

### 4.0x3.0mm RIGHT ANGLE SMD CHIP LED **LAMP**

PRELIMINARY SPEC

Part Number: APEKA4030MGC

Mega Green

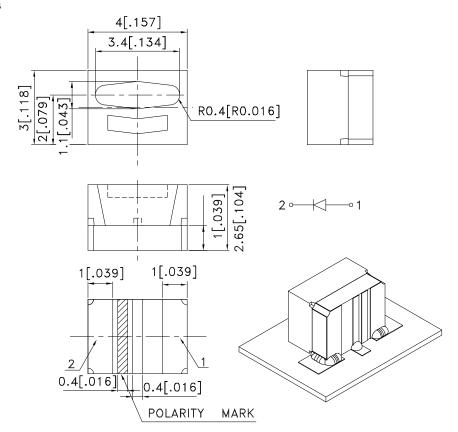
#### **Features**

- 4.0mmx3.0mm right angle SMT LED, 2.65mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package :500pcs / reel.
- Moisture sensitivity level : level 4.
- RoHS compliant.

### Description

The Mega Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

# **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2 (0.008")$  unless otherwise noted.
- Specifications are subject to change without notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.





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## **Selection Guide**

Part No.	Dice	lv (mcd) [2] Lens Type @ 20mA		,	Viewing Angle [1]
		-	Min.	Тур.	201/2
APEKA4030MGC	Mega Green (AlGaInP)	WATER CLEAR	50	100	90°

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Mega Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Mega Green	570		nm	I=20mA
Δλ1/2	Spectral Line Half-width	Mega Green	26		nm	I==20mA
С	Capacitance	Mega Green	20		pF	V <sub>F</sub> =0V;f=1MHz
VF [2]	Forward Voltage	Mega Green	2.1	2.5	V	I==20mA
lr	Reverse Current	Mega Green		10	uA	V <sub>R</sub> =5V

# Notes:

- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

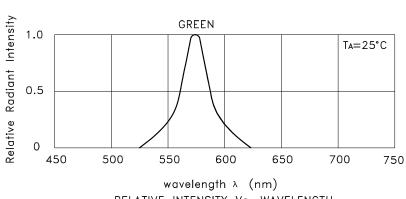
#### Absolute Maximum Ratings at TA=25°C

Parameter	Mega Green	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

#### Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

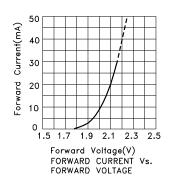
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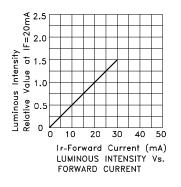


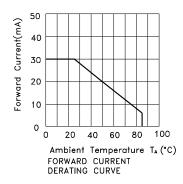
RELATIVE INTENSITY Vs. WAVELENGTH

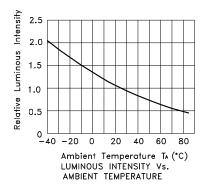
# Mega Green

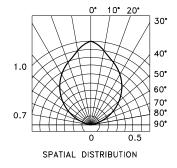
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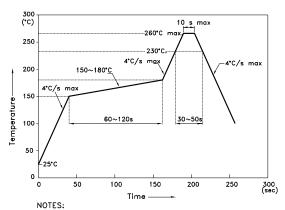


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#### APEKA4030MGC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

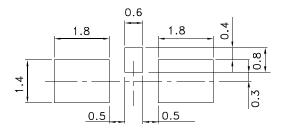
Reflow Soldering Profile For Lead-free SMT Process.



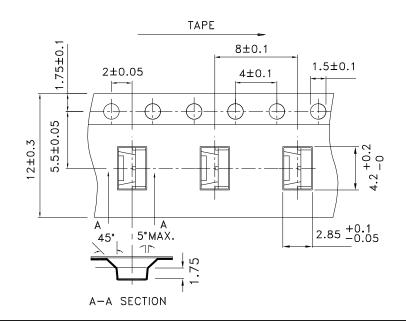
- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

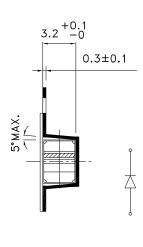
  3.Number of reflow process shall be 2 times or less.

## **Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)

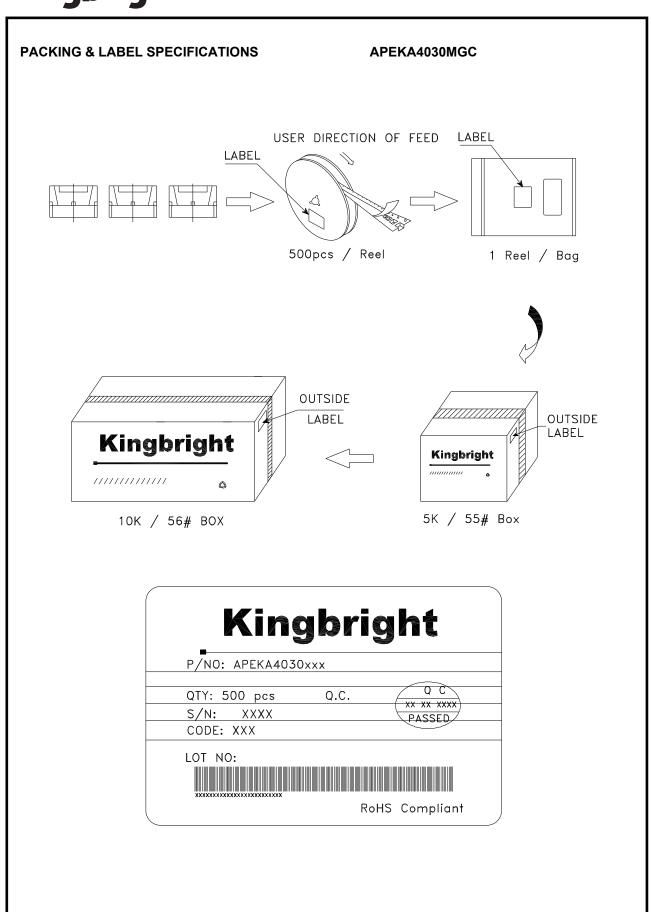


# **Tape Dimensions** (Units: mm)





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